

L Number	Hits	Search Text	DB	Time stamp
1	84886	substrate WITH via	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/05 10:40
3	46930	magnetic NEAR core	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/05 10:41
4	529	(substrate WITH via) and (magnetic NEAR core)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/05 10:40
5	414	((substrate WITH via) and (magnetic NEAR core)) and conduct\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/05 10:45
6	374	((((substrate WITH via) and (magnetic NEAR core)) and conduct\$3) and (coil winding)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/05 10:46